



# Antenna Datasheet

**Product OC:** YFNP001WWA

**Product OC (Antenna + EVB):** YFNP001WWAEVB

**Version:** 1.1

**Date:** 2024-10-15

**Status:** Released

**Product Name:** ISM SMT Mount PCB Loop Antenna

**Key Features:**

Frequency band: 900–930 MHz

Dimensions: 10 mm × 3.2 mm × 0.6 mm

Efficiency: Up to 47.73 %

RoHS compliant

# Overview

The Quectel YFNP001WWA is a compact form factor SMT mount PCB antenna for ISM applications. Due to the dimensions of 10 × 3.2 × 0.6 mm, it is designed for very small space requirements for Medical Devices, Smart Monitoring, Smart Home. The YFNP001WWA is a ground-dependent loop antenna, uses main PCB as its ground plane. It is delivered on tape and reel.

The YFNP001WWA is a PCB antenna, which can be mounted on super compact space require terminals. Despite of this small factor, it has up to 47.73 % efficiency in working bands. This antenna is developed on a 90 × 45 mm evaluation board. If the devices have different ground sizes, matching circuit can be used to tune the resonant frequency correctly. We also offer gerber file, 2D & 3D documents for PCB layout.

The YFNP001WWA allows high efficiency, stable signal transmission and reception for ISM working bands in 900–930 MHz. This product is RoHS compliant.

Typical applications include:

- Medical Devices
- Smart Monitoring
- Smart Home

Quectel provides comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs. We have regional R & D centers to offer quick response to meet your requirements. Please contact our sales & FAEs if you have any requests.

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# 1 Specification

Test Condition: Assembled on 90 mm × 45 mm EVB

## 1.1. Electrical

| Electrical        |                  |
|-------------------|------------------|
| Frequency Range   | 900–930 MHz      |
| Impedance         | 50 Ω             |
| Polarization      | Linear           |
| Radiation Pattern | Omni-directional |

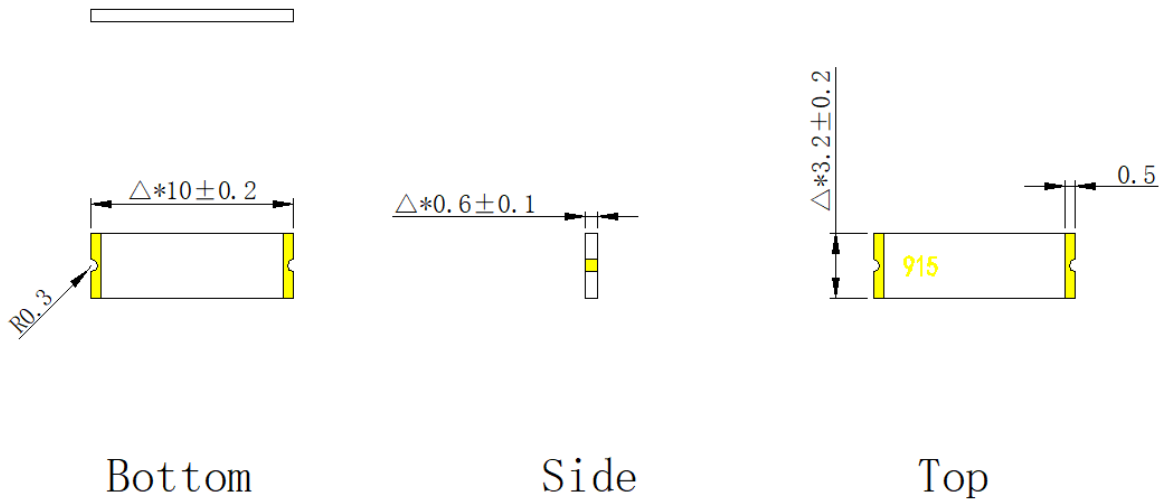
| Electrical – Detail  |      |             |         |               |             |            |           |           |           |
|----------------------|------|-------------|---------|---------------|-------------|------------|-----------|-----------|-----------|
| Spec                 | Band | Band        | ISM 915 | B12 /B13 /B28 | B5 /B8 /B26 | B1 /B2 /B3 | B40       | Wi-Fi 2G  | B38 /B41  |
|                      |      | Freq. (MHz) | 900–930 | 700–810       | 820–960     | 1700–2170  | 2300–2400 | 2400–2500 | 2500–2690 |
| Max VSWR             |      |             | 2.7     | -             | -           | -          | -         | -         | -         |
| Max Return Loss (dB) |      |             | -6.8    | -             | -           | -          | -         | -         | -         |
| AVG Eff. (%)         |      |             | 42.2    | -             | -           | -          | -         | -         | -         |
| AVG Gain (dB)        |      |             | -3.8    | -             | -           | -          | -         | -         | -         |
| Max Peak Gain (dBi)  |      |             | 0.4     | -             | -           | -          | -         | -         | -         |

## 1.2. Mechanical & Environmental

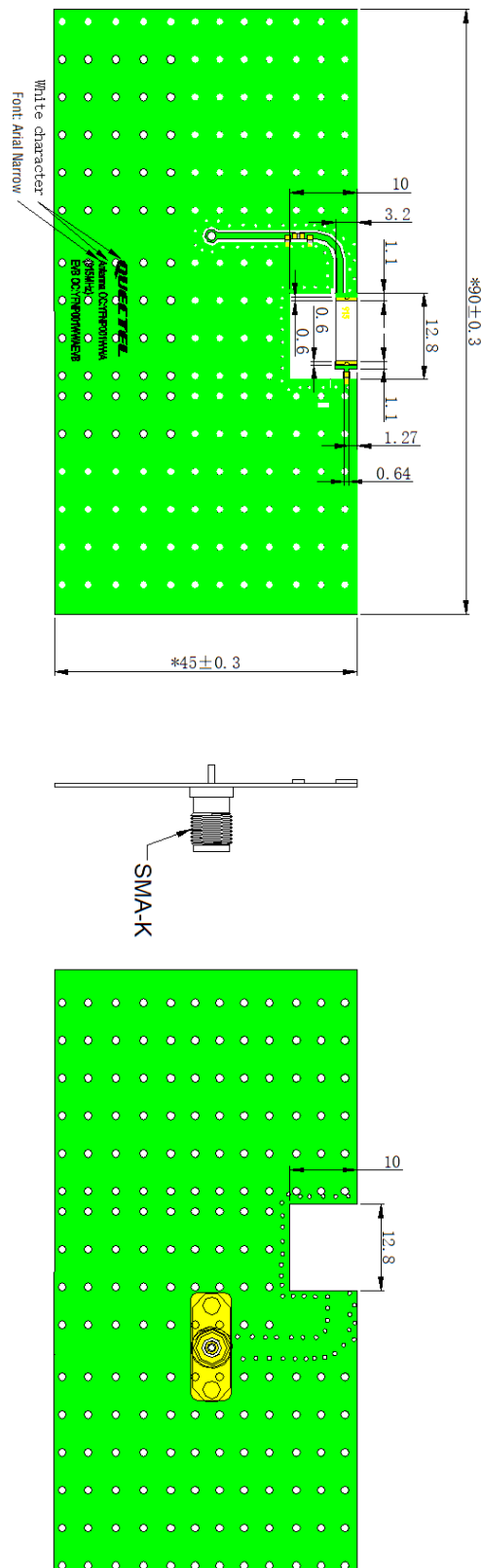
| Mechanical            |                         |
|-----------------------|-------------------------|
| Antenna Dimensions    | 10 mm × 3.2 mm × 0.6 mm |
| Material & Color      | PCB & Black             |
| Mounting Type         | SMD                     |
| Weight                | Typ. 0.05 g             |
| Recommended EVB Size  | 90 × 45 × 0.6 mm        |
| Environmental         |                         |
| Operation Temperature | -40 °C to +85 °C        |
| Storage Temperature   | -40 °C to +85 °C        |
| RoHS Compliant        | Yes                     |

## 2 Drawing

### 2.1. Antenna



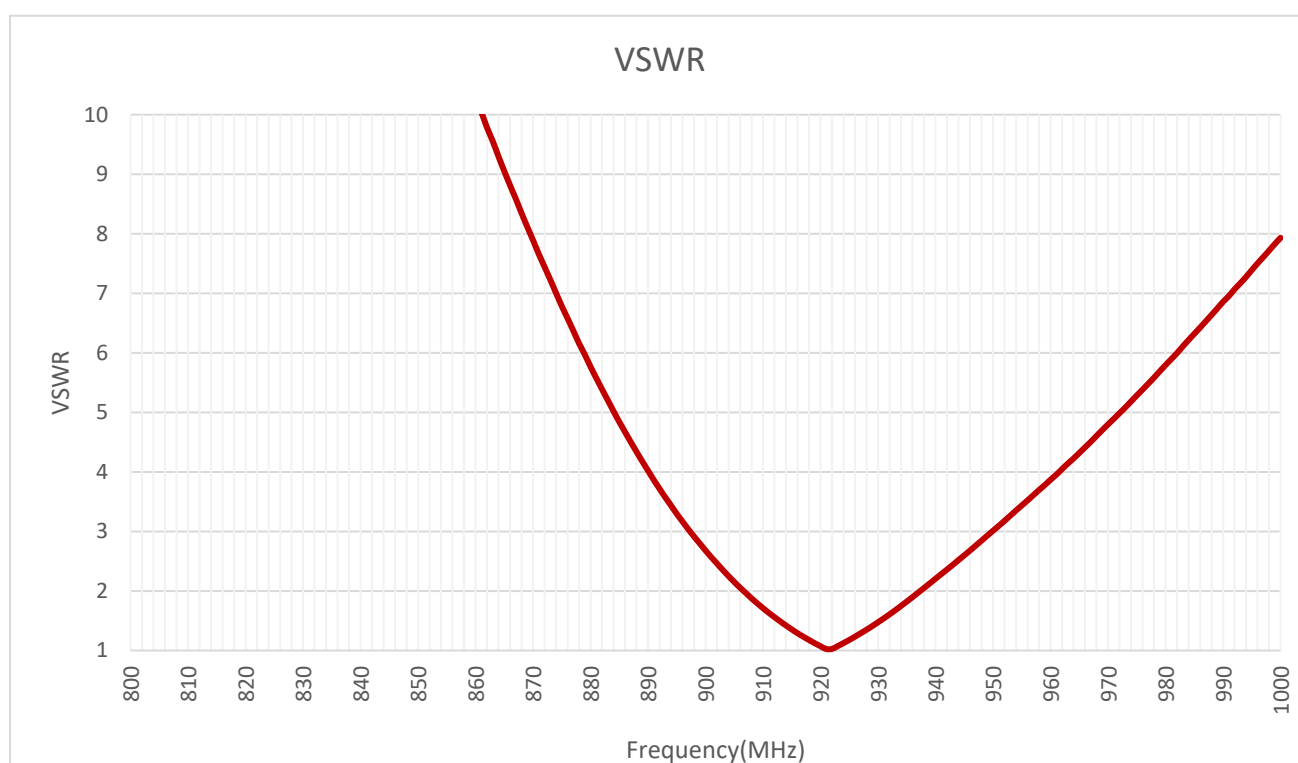
## 2.2. EVB



## 3 Detailed Performance

### 3.1. S-Parameter Test

#### 3.1.1. VSWR

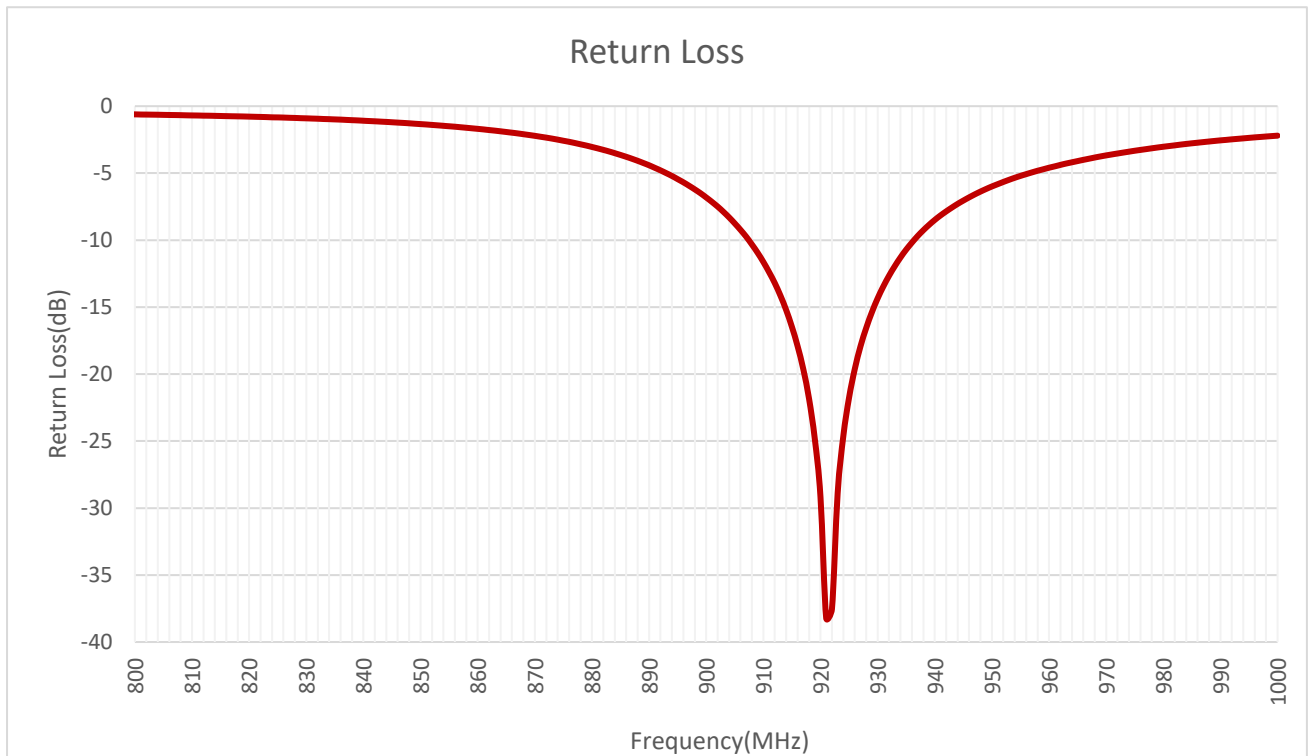


**VSWR**

| Frequency (MHz) | 433 | 450 | 470 | 490 | 510 | 860 | 863 | 868 | 870 | 910 | 915 | 930 |
|-----------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| VSWR            | -   | -   | -   | -   | -   | -   | -   | -   | -   | 1.7 | 1.4 | 1.5 |



### 3.1.2. Return Loss

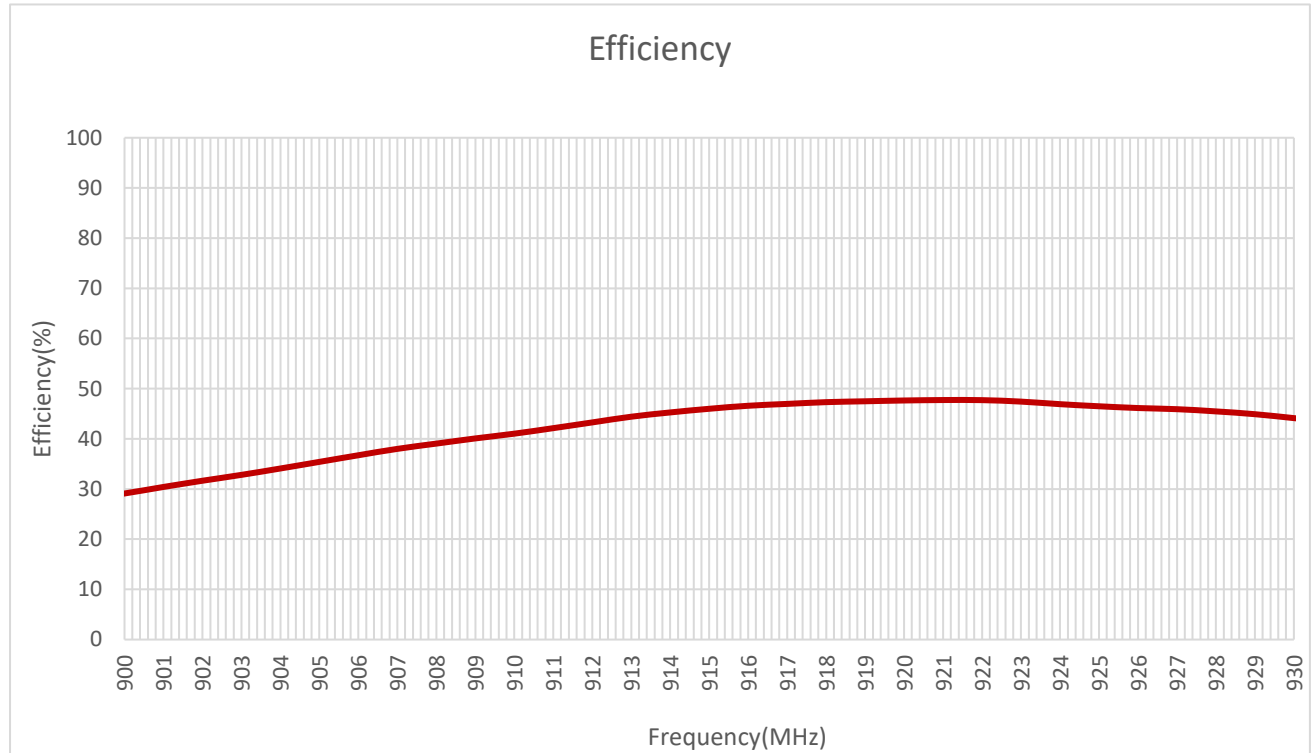


**Return Loss (dB)**

| Frequency (MHz)  | 433 | 450 | 470 | 490 | 510 | 860 | 863 | 868 | 870 | 910   | 915   | 930   |
|------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-------|-------|-------|
| Return Loss (dB) | -   | -   | -   | -   | -   | -   | -   | -   | -   | -11.6 | -16.5 | -14.3 |

## 3.2. Radiation Performance Test

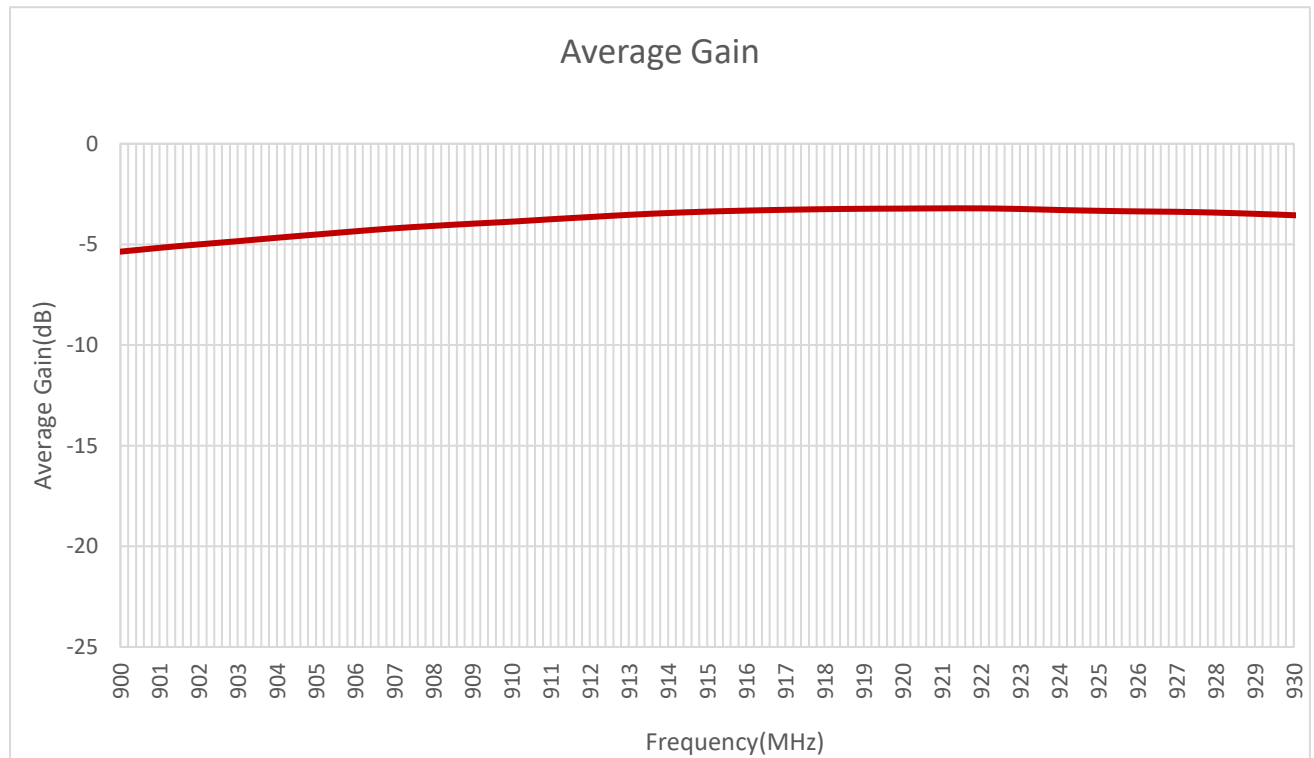
### 3.2.1. Efficiency



**Efficiency (%)**

| Frequency (MHz) | 433 | 450 | 470 | 490 | 510 | 860 | 863 | 868 | 870 | 910  | 915  | 930  |
|-----------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|
| Efficiency (%)  | -   | -   | -   | -   | -   | -   | -   | -   | -   | 41.0 | 46.0 | 44.1 |

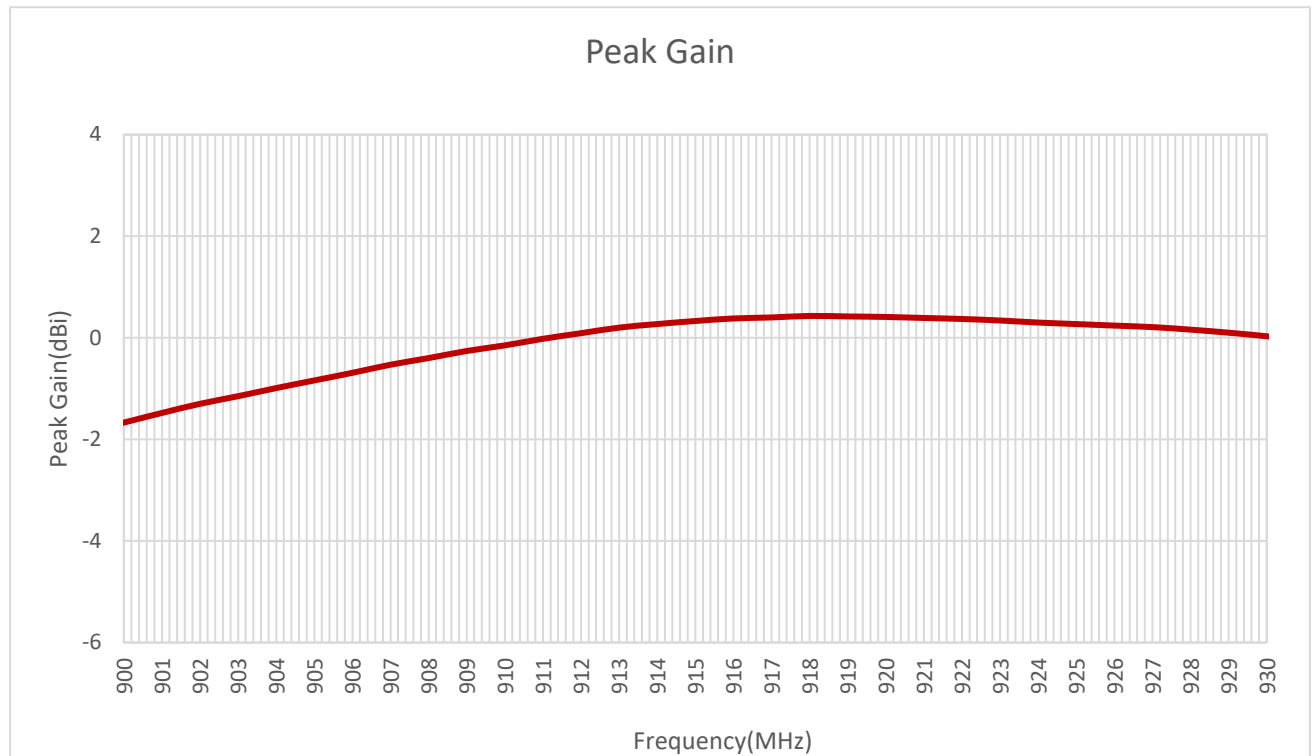
### 3.2.2. Average Gain



**Average Gain (dB)**

| Frequency (MHz)   | 433 | 450 | 470 | 490 | 510 | 860 | 863 | 868 | 870 | 910  | 915  | 930  |
|-------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|
| Average Gain (dB) | -   | -   | -   | -   | -   | -   | -   | -   | -   | -3.9 | -3.4 | -3.6 |

### 3.2.3. Peak Gain

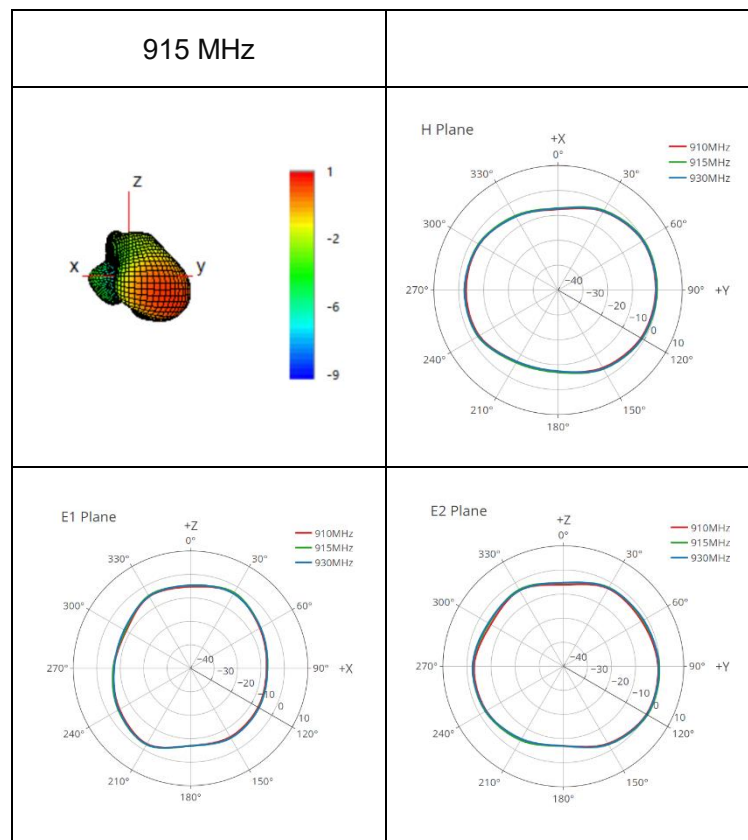
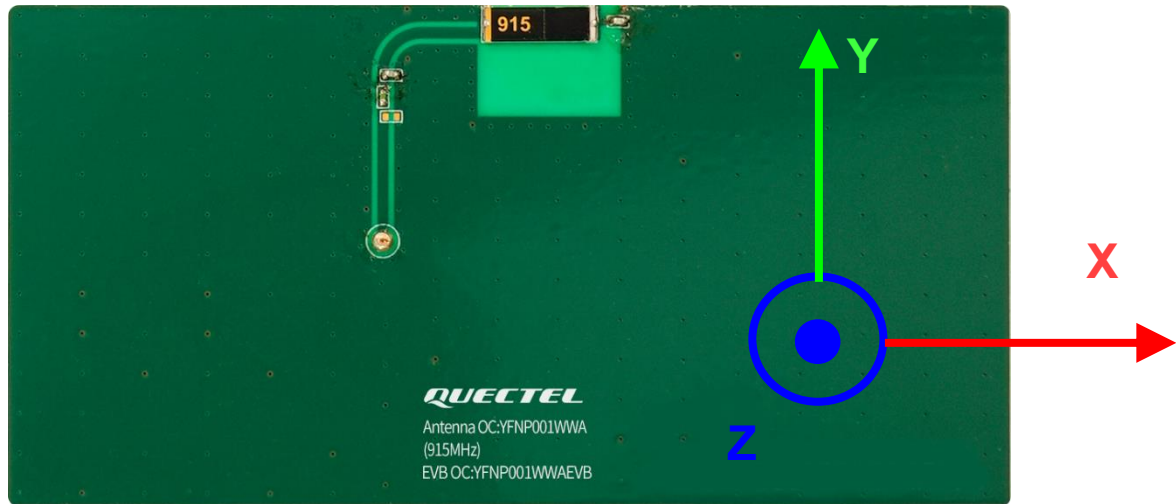


**Peak Gain (dBi)**

| Frequency (MHz) | 433 | 450 | 470 | 490 | 510 | 860 | 863 | 868 | 870 | 910  | 915 | 930 |
|-----------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|-----|-----|
| Peak Gain (dBi) | -   | -   | -   | -   | -   | -   | -   | -   | -   | -0.2 | 0.3 | 0.0 |

### 3.2.4. 3D & 2D Radiation Pattern

- Test Condition: Assembled on 90 mm × 45 mm EVB
- Test Chamber: GL-G-1



## 4 Schematic Symbol and Pin Definition

- The pin assignment for the antenna is as follows.

| Pin | Description |
|-----|-------------|
| 1   | Feed        |
| 2   | GND         |



**Bottom**



**TOP**

## 5 Transmission Line

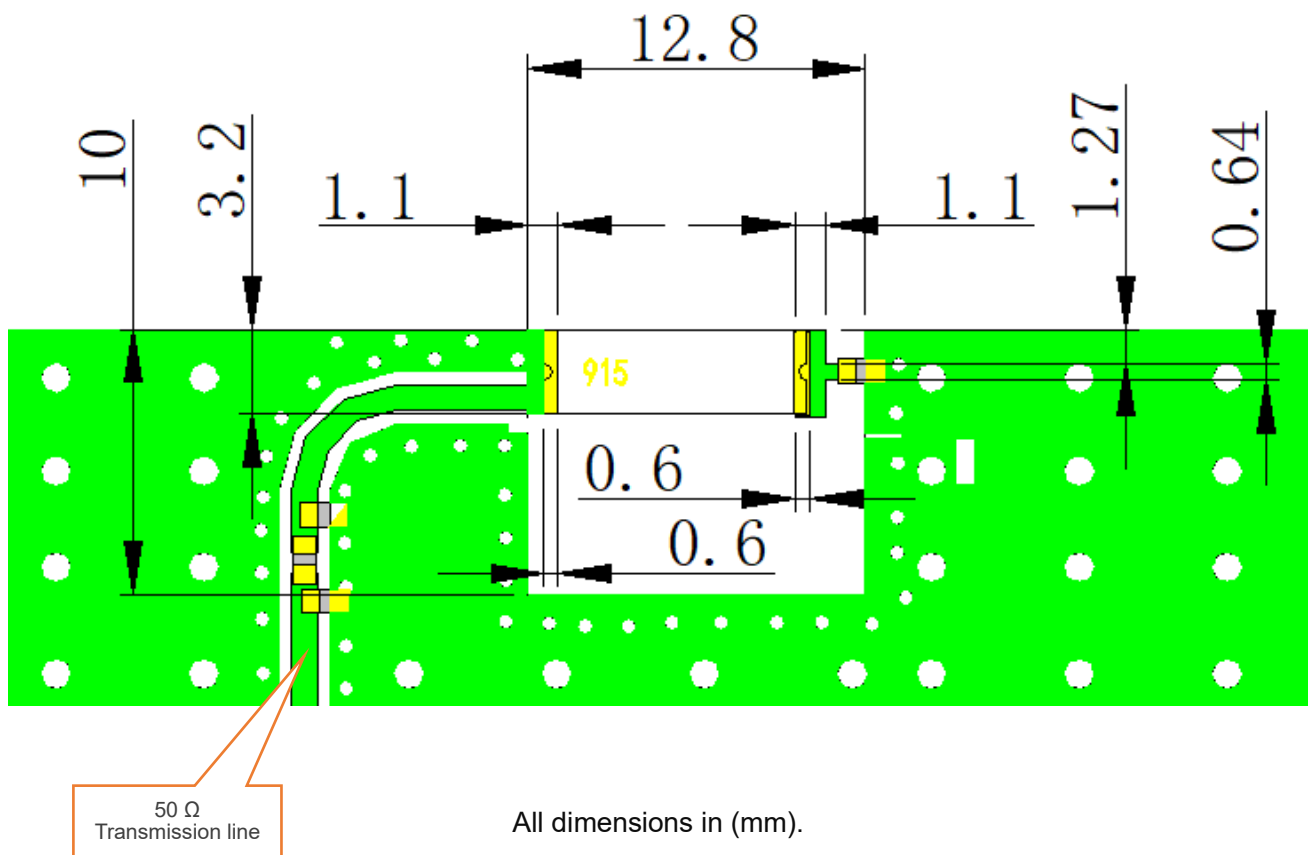
The characteristic impedance of all transmission lines shall be designed as 50  $\Omega$ .

- The length of the transmission lines should be kept as short as possible.
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50  $\Omega$ .

Once the material for the PCB has been chosen (PCB thickness and dielectric constant), a coplanar transmission line can easily be designed using any of the commercial software packages for transmission line design. For the chosen PCB thickness, copper thickness and substrate dielectric constant, the program will calculate the appropriate transmission line width and gaps on either side of the track so the characteristic impedance of the coplanar transmission is 50  $\Omega$ .

## 6 Recommended PCB Layout

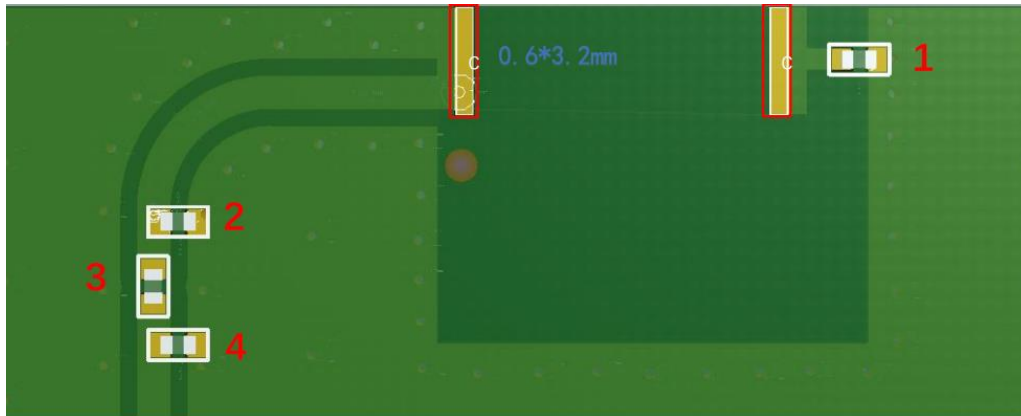
The host PCB must be designed using the PCB footprint shown with the correct clearances. An example of the PCB layout shows the antenna footprint. Please note this clearance area is critical to the performance of the antenna and must be applied through all layers of the PCB.





## 7 Matching Circuit

Demo Board Top View

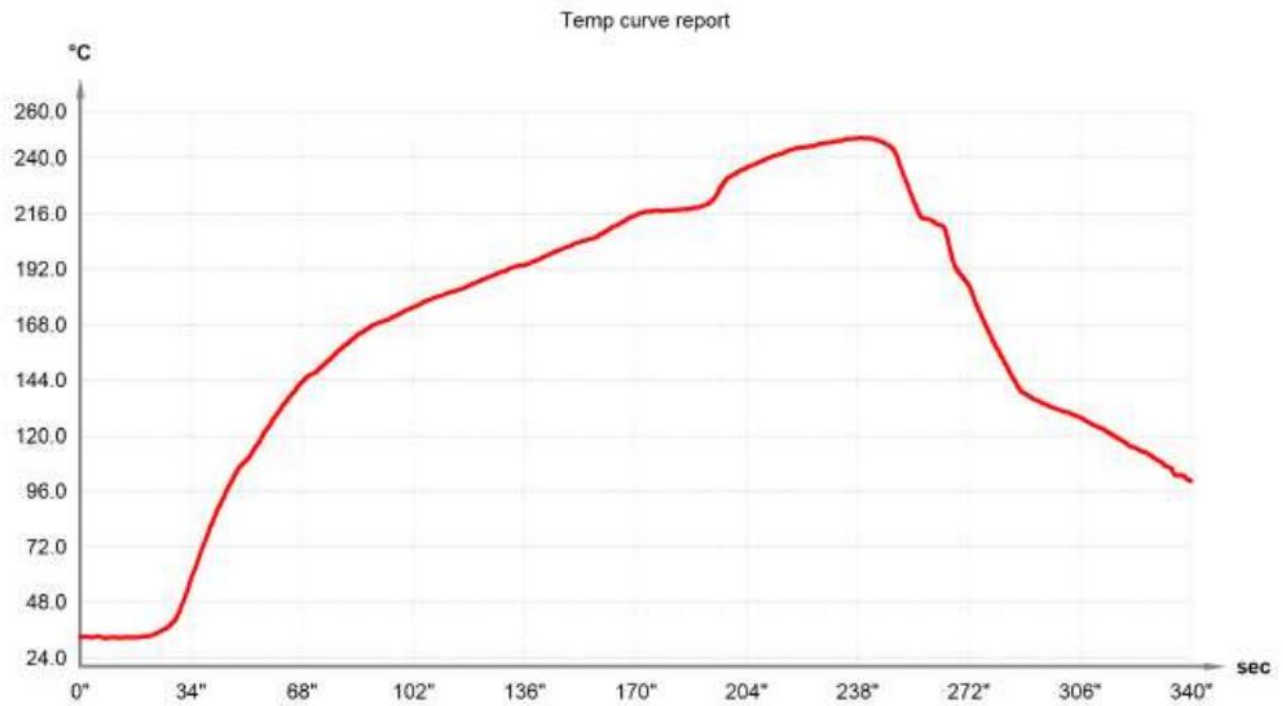


|                         | 1      | 2      | 3      | 4  |
|-------------------------|--------|--------|--------|----|
| <b>Default Matching</b> | 11 pF  | 7 pF   | 9.1 nH | NC |
| <b>Vender</b>           | MURATA | MURATA | MURATA | NC |


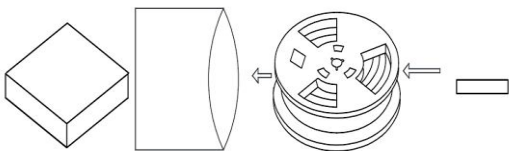
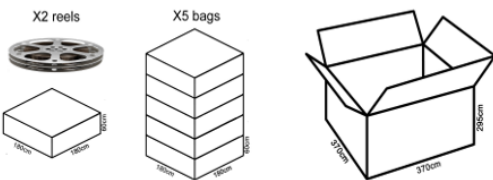
## 8 Soldering Temperature

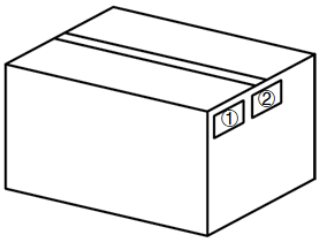
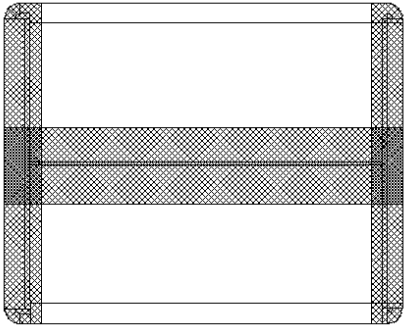
| Channels       | Name | Heating time<br>150.0-200.0°C | Above temp<br>217.0°C | Top temp      | Heating slope<br>150.0-180.0°C | Cooling slope<br>180.0-150.0°C |
|----------------|------|-------------------------------|-----------------------|---------------|--------------------------------|--------------------------------|
| 1              | Pin1 | 73"                           | 82"                   | 248.7         | 0.97                           | -2.92                          |
|                |      |                               |                       |               |                                |                                |
|                |      |                               |                       |               |                                |                                |
|                |      |                               |                       |               |                                |                                |
|                |      |                               |                       |               |                                |                                |
|                |      |                               |                       |               |                                |                                |
| Refrence value |      | 70.0-95.0s                    | 70.0-90.0s            | 240.0-250.0°C | 0.0-3.0°C/s                    | -4.0--1.0°C/s                  |

## 9 Reflow Profile



# 10 Packaging

| Step | Packaging picture / 2D picture  | Description   |
|------|---|---|
| 1    |    | Reel  |
| 2    |  | (5000 Antenna Products / Reel)<br>2 reels of tapes are vacuumed into the inner box.   |
| 3    |  | (5 Inner Boxes / Carton Box)<br>(50000 PCS / Carton Box)<br>Estimated quantity<br><br>Products that cannot fill the entire carton box are packed in a suitable size carton box.<br><u>Carton Size:</u><br><u>L × W × H = 370 × 370 × 295 mm</u> |

|      |  |   |
|------|--|---|
| 4    |   | <b>Position for Attaching Labels</b><br>① Carton Label<br>② Quality Label |
| 5    |   | <b>Sealing Cartons</b><br>“I” type sealing cartons                        |
| Note | The initial packaging method described above is for reference only, and the final actual packaging method shall be subject to the actual shipping packaging. |   |

# Contact Us

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# Revision History

| Version | Date       | Author  | Note   |
|---------|------------|---|--|
| -       | 2024-04-23 | Sly LIU/<br>Hart HU/<br>David LIU/<br>Rainey LIAO | Creation of the document                                       |
| 1.0     | 2024-04-23 | Sly LIU/<br>Hart HU/<br>David LIU/<br>Rainey LIAO | First official release   |
| 1.1     | 2024-10-15 | Mayes LI/<br>Bill MO                              | 1. Updated the drawing (Chapter 2.1).<br>2. Updated Chapter 4. |



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